



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C	
		0.99Ω @ V _{GS} = 4.5V	450mA	
01	Q1 20V	1.2Ω @ V _{GS} = 2.5V	400mA	
QI		1.8Ω @ V _{GS} = 1.8V	330mA	
		2.4Ω @ V _{GS} = 1.5V	300mA	
		1.9Ω @ V _{GS} = -4.5V	-310mA	
Q2	2014	-20V 2.4Ω @ V _{GS} = -2.4		-280mA
QZ	-201	3.4Ω @ V _{GS} = -1.8V	-240mA	
		5Ω @ V _{GS} = -1.5V	-180mA	

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- General Purpose Interfacing Switch
- Power Management Functions
- Analog Switch



- Low On-Resistance
- Very low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 1mm x 1mm
- Low Package Profile, 0.45mm Maximum Package height
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3 & 4)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: SOT963
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)

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Transistor Diagram

• Weight: 0.027 grams (approximate)



Ordering Information (Note 5 & 6)

Part Number	Case	Packaging
DMC2990UDJ-7	SOT963	10K/Tape & Reel
DMC2990UDJ-7B	SOT963	10K/Tape & Reel

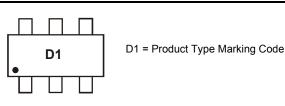
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

4. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.

5. The options -7 and -7B stand for different taping orientations. Please refer to Diodes website at http://www.diodes.com for further details.

6. For packaging details, go to our website at http"//www.diodes.com/products/packages.html

Marking Information



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^{2.} See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

^{3.} Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Maximum Ratings Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units		
Drain-Source Voltage			V _{DSS}	20	V	
Gate-Source Voltage			V _{GSS}	±8	V	
	Steady State	T _A = +25°C T _A = +70°C	ID	450 350	mA	
Continuous Drain Current (Note 7) V_{GS} = 4.5V	t<5s	T _A = +25°C T _A = +70°C	Ι _D	520 410	mA	
	Steady State	T _A = +25°C T _A = +70°C	Ι _D	330 260	mA	
Continuous Drain Current (Note 7) V _{GS} = 1.8V	t<5s	T _A = +25°C T _A = +70°C	ID	390 310	mA	
Maximum Continuous Body Diode Forward Currer		ls	440	mA		
Pulsed Drain Current (Note 8)	I _{DM}	800	mA			

Maximum Ratings Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±8	V	
	Steady State	T _A = +25°C T _A = +70°C	ID	-310 -240	mA
Continuous Drain Current (Note 5) V_{GS} = -4.5V	t<5s	T _A = +25°C T _A = +70°C	Ι _D	-360 -280	mA
	Steady State	T _A = +25°C T _A = +70°C	Ι _D	-240 -190	mA
Continuous Drain Current (Note 5) V_{GS} = -1.8V	t<5s	T _A = +25°C T _A = +70°C	Ι _D	-280 -220	mA
Maximum Continuous Body Diode Forward Curren		Is	-440	mA	
Pulsed Drain Current (Note 8)			I _{DM}	-800	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 7)		PD	350	mW
Thermal Resistance, Junction to Ambient (Note 7)	Steady State	Devi	360	°C/W
	t<5s	R _{0JA}	270	°C/W
Operating and Storage Temperature Range		$T_{J,} T_{STG}$	-55 to +150	°C

Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout.
 Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.



Electrical Characteristics Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	V _{GS} = 0V, I _D = 250µA
Zana Oata Maltana Dasia Ourrant		-	-	100	nA	V _{DS} = 16V, V _{GS} = 0V
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	IDSS	-	-	50		$V_{DS} = 5V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V _{GS(th)}	0.4	-	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
		-	0.60	0.99		V _{GS} = 4.5V, I _D = 100mA
		-	0.75	1.2		V _{GS} = 2.5V, I _D = 50mA
Static Drain-Source On-Resistance	R _{DS(ON)}	-	0.90	1.8	Ω	V _{GS} = 1.8V, I _D = 20mA
		-	1.2	2.4		V _{GS} = 1.5V, I _D = 10mA
		-	2.0	-		V _{GS} = 1.2V, I _D = 1mA
Forward Transfer Admittance	Y _{fs}	180	850	-	mS	V _{DS} = 5V, I _D = 125mA
Diode Forward Voltage	V _{SD}	-	0.6	1.0	V	V _{GS} = 0V, I _S = 10mA
DYNAMIC CHARACTERISTICS (Note 10)						·
Input Capacitance		-	27.6	-	pF	
Output Capacitance	Coss	-	4.0	-	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	-	2.8	-	pF	1 - 1.00012
Gate Resistance	R_{G}	-	113	-	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz
Total Gate Charge	Qg	-	0.5	-	nC	V _{GS} = 4.5V, V _{DS} = 10V,
Gate-Source Charge	Q _{gs}	-	0.07	-	nC	I _D = 250mA
Gate-Drain Charge	Q _{qd}	-	0.07	-	nC	
Turn-On Delay Time	t _{D(on)}	-	4.0	-	ns	
Turn-On Rise Time	tr	-	3.3	-	ns	$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(off)}	-	19.0	-	ns	$R_L = 47\Omega, R_G = 2\Omega,$
Turn-Off Fall Time	t _f	-	6.4	-	ns	– I _D = 200mA

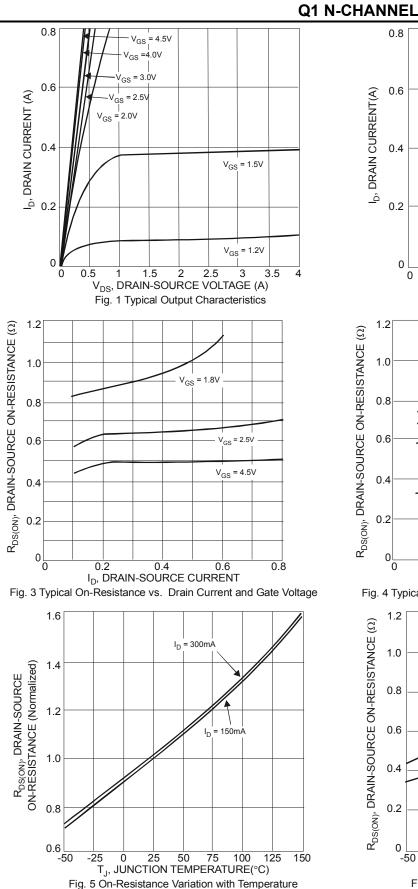
Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

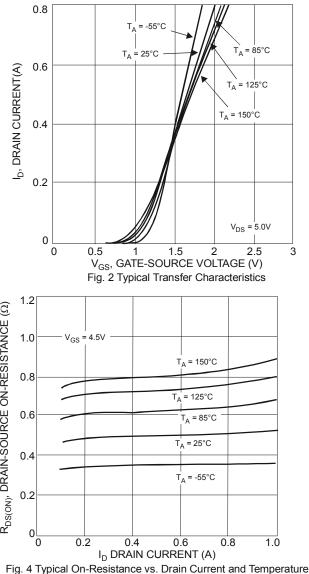
Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage		-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zana Cata Maltana Duain Currant		-	-	100	nA	V _{DS} = -16V, V _{GS} = 0V
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}$	C I _{DSS}	-	-	50		V_{DS} = -5V, V_{GS} = 0V
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V _{GS(th)}	-0.4	-	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
		-	1.2	1.9		V _{GS} = -4.5V, I _D = -100mA
		-	1.5	2.4		V _{GS} = -2.5V, I _D = -50mA
Static Drain-Source On-Resistance	R _{DS(ON)}	-	2.1	3.4	Ω	V _{GS} = -1.8V, I _D = -20mA
	. ,	-	2.5	5		V _{GS} = -1.5V, I _D = -10mA
		-	4.0	-		V _{GS} = -1.2V, I _D = -1mA
Forward Transfer Admittance		100	450	-	mS	V _{DS} = -5V, I _D = -125mA
Diode Forward Voltage	V _{SD}	-	-0.6	-1.0	V	V _{GS} = 0V, I _S = -10mA
DYNAMIC CHARACTERISTICS (Note 10)						<u> </u>
Input Capacitance	Ciss	-	28.7	-	pF	
Output Capacitance	Coss	-	4.2	-	pF	V _{DS} = -15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	-	2.9	-	pF	
Gate Resistance	R _G	-	399	-	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz
Total Gate Charge	Qq	-	0.4	-	nC	
Gate-Source Charge	Qqs	-	0.08	-	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$
Gate-Drain Charge	Q _{gd}	-	0.06	-	nC	$-I_{\rm D} = -250 {\rm mA}$
Turn-On Delay Time	t _{D(on)}	-	5.8	-	ns	
Turn-On Rise Time	tr	-	5.7	-	ns	V _{DD} = -15V, V _{GS} = -4.5V,
Turn-Off Delay Time	t _{D(off)}	-	31.1	-	ns	$R_{G} = 2\Omega, I_{D} = -200 \text{mA}$
Turn-Off Fall Time	tf	-	16.4	-	ns	1

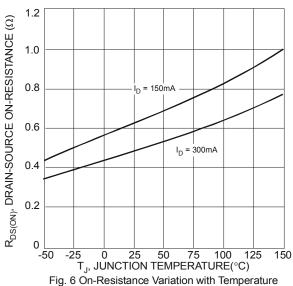
Notes: 9. Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



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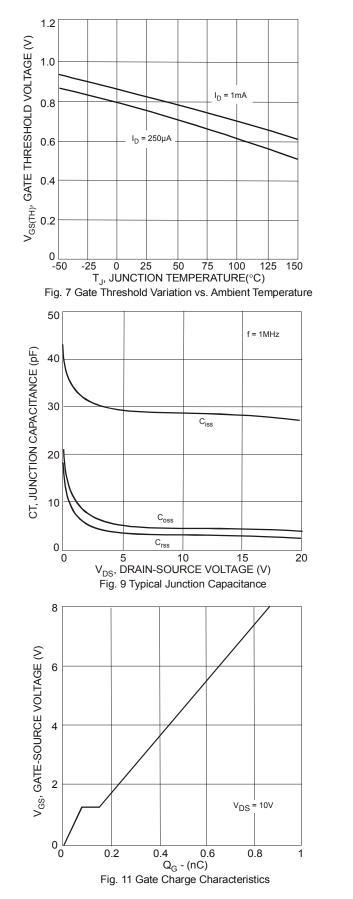


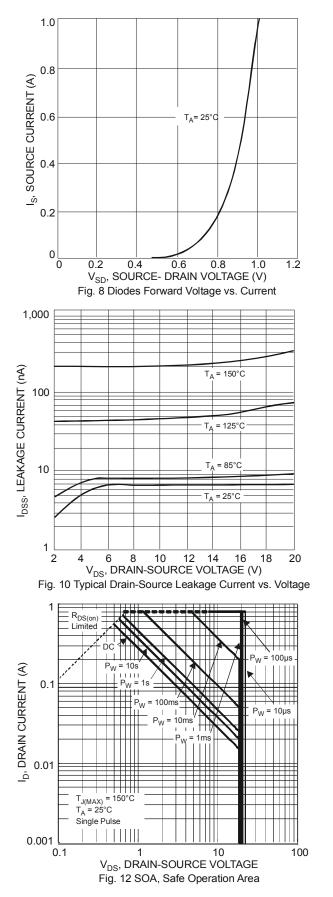


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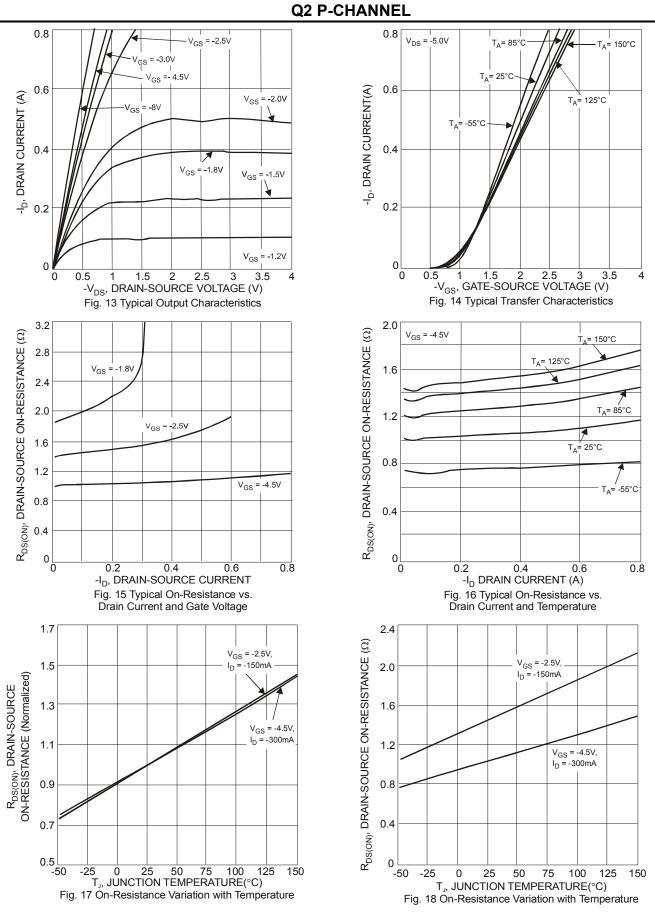




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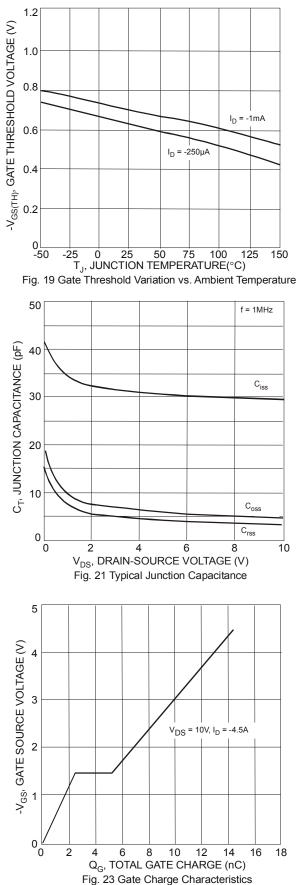
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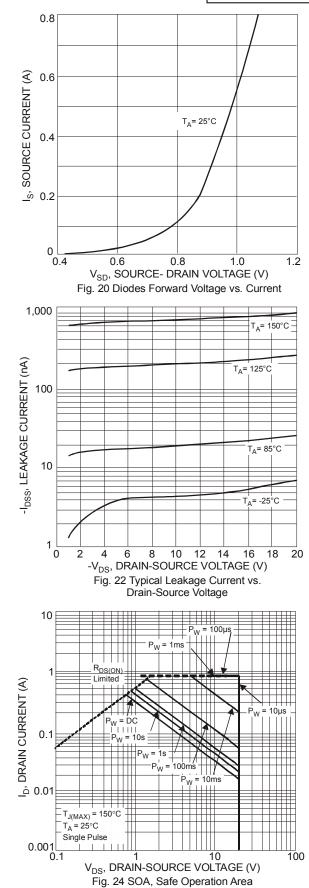


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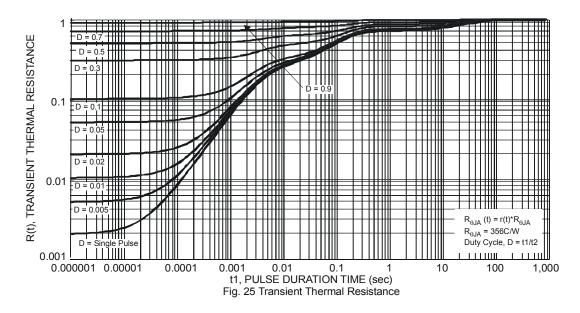




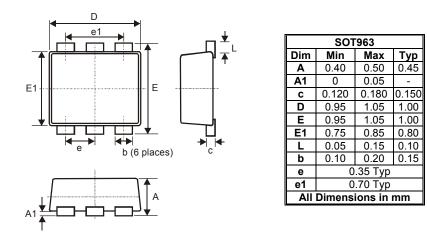




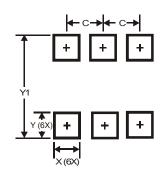




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
С	0.350
Х	0.200
Y	0.200
Y1	1.100



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